





DIP4, AC Input, Photo Transistor Coupler

Description

The TD814 series combine two AlGaAs infrared emitting diodes as the AC input which is optically coupled to a silicon planar phototransistor detector in a plastic DIP4 package with different lead forming options.

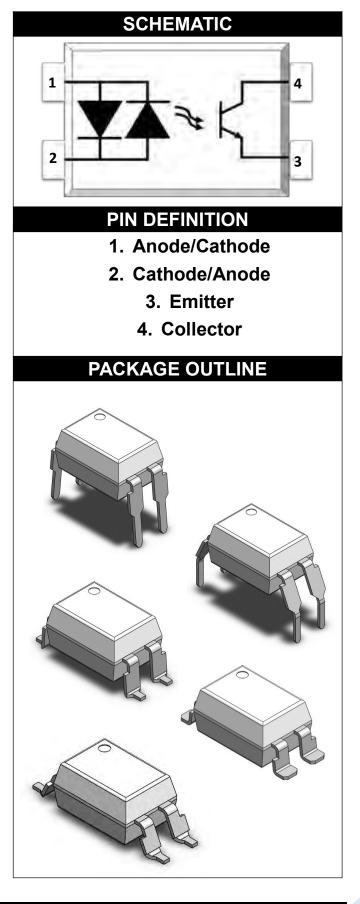
With the robust coplanar double mold structure, TD814 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- AC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

Applications

- AC line monitor
- Programmable controller
- Telephone line interface
- System appliance
- Measurement instrument



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ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	IF	±60	mA				
Peak Forward Current	I _{FP}	±1	A	1			
Reverse Voltage	V _R	6	V				
Input Power Dissipation	Pi	100	mW				
TUO	OUTPUT						
Collector - Emitter Voltage	V _{CEO}	80	V				
Emitter - Collector Voltage	V _{ECO}	6	V				
Collector Current	lc	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \approx 60\%$



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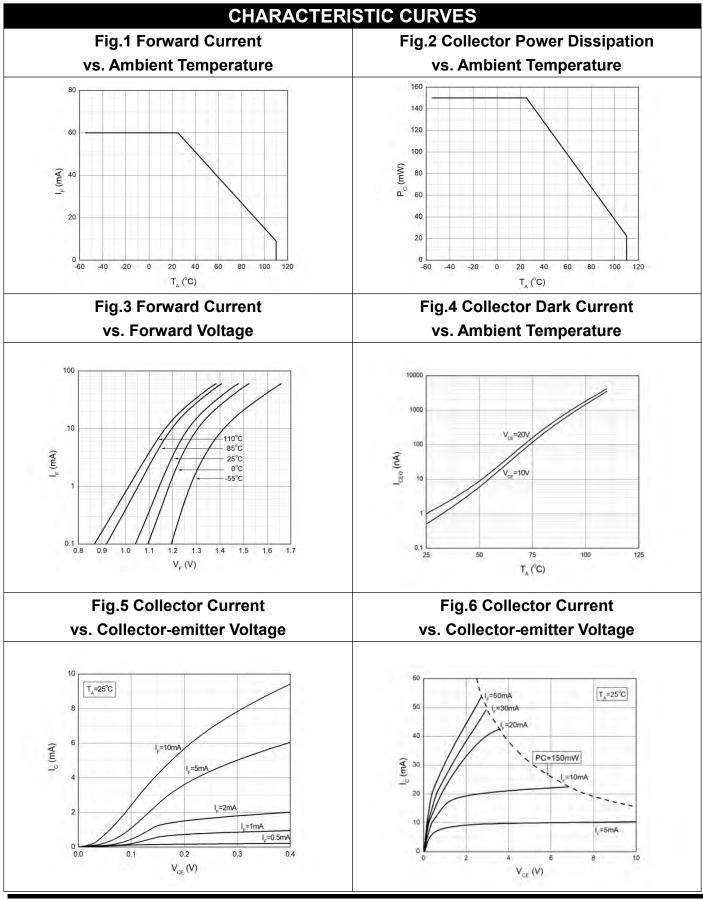
	ELECT	RICAL OI	PTICA	L CHA	ARAC	TER	ISTICS at Ta=25°C	
PARAME	ETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	INPUT							
Forward V	/oltage	VF	-	1.24	1.4	V	IF=±10mA	
Input Capa	icitance	Cin	-	10	-	pF	V=0, f=1kHz	
				OUT	PUT			
Collector Dar	k Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0	
Collector-I Breakdown		BV _{CEO}	80	-	-	V	IC=0.1mA, IF=0	
Emitter-Co Breakdown		BV _{ECO}	6	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS								
Current	TD814		20	-	300			
Transfer	TD814A	CTR	50	-	150	%	IF=±1mA, VCE=5V	
Ratio	TD814B		80	-	400			
CTF	R Symmetr	у	0.7	-	1.3		IF=±1mA, VCE=5V	
Collector-I Saturation		V _{CE(sat)}	-	0.06	0.2	V	IF=±20mA, IC=1mA	
Isolation Re	sistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		CIO	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)		tr	-	3	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)		tf	-	4	18	μs	RL=100Ω	3
Cut-off Fre	quency	fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4

Note 3. Fig.12&13 Note 4. Fig.14

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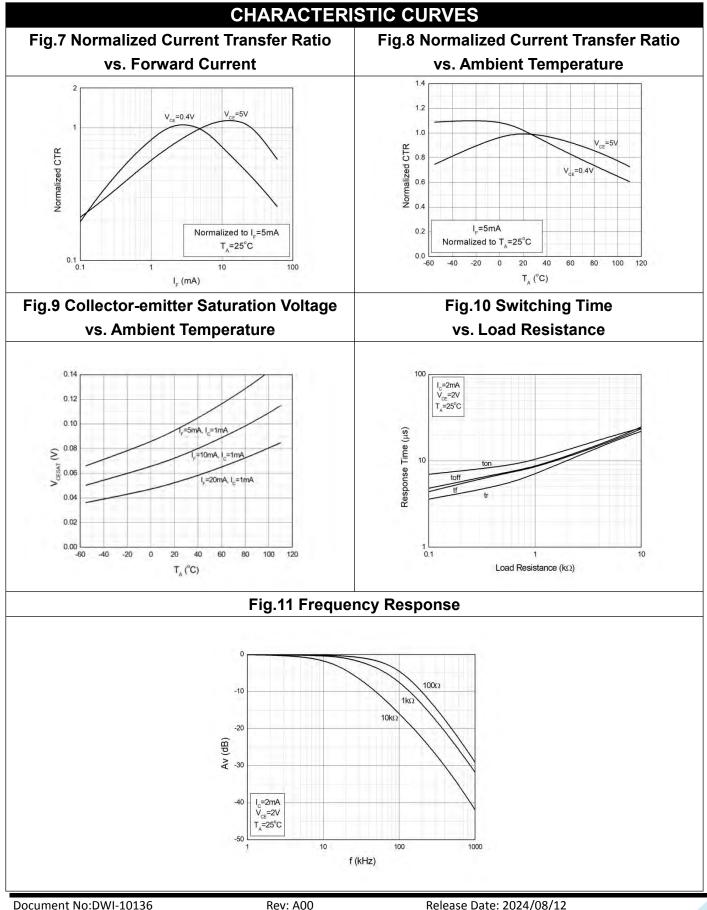
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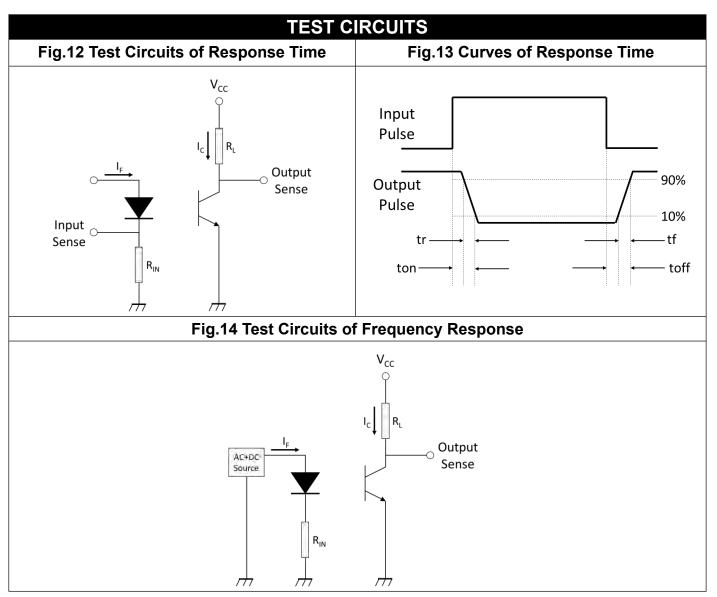




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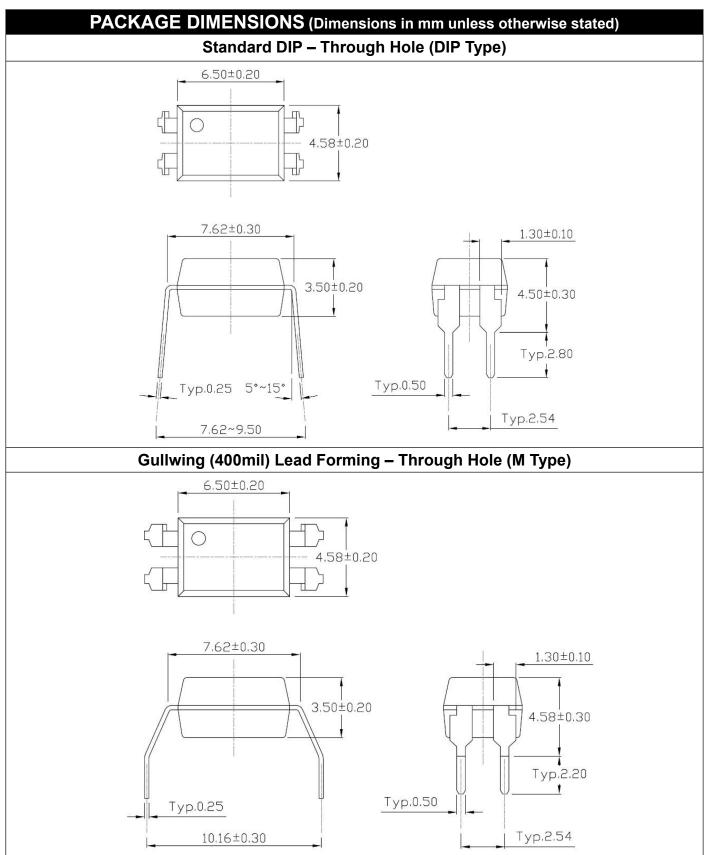
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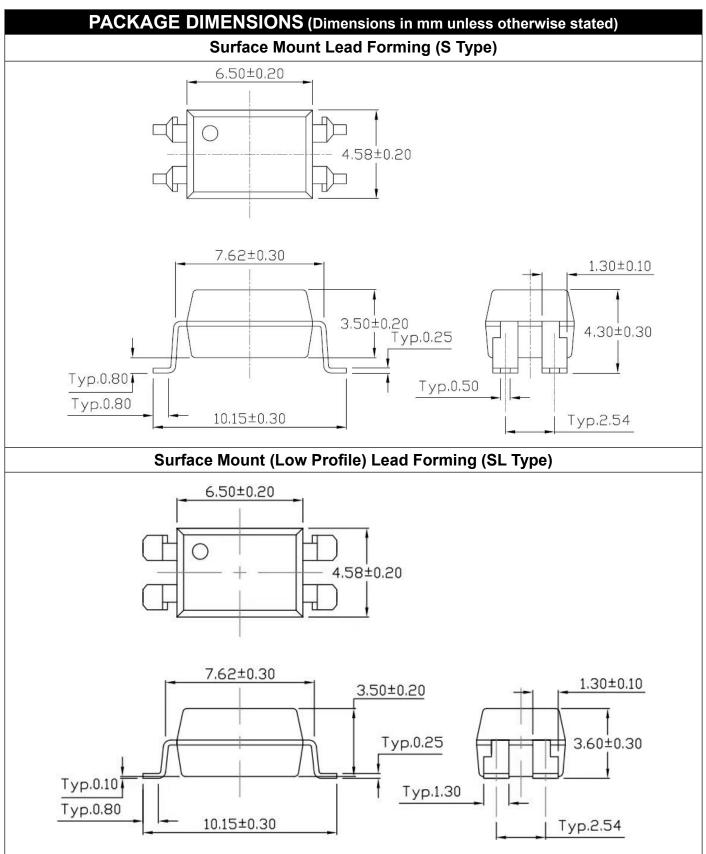
TD814 Series





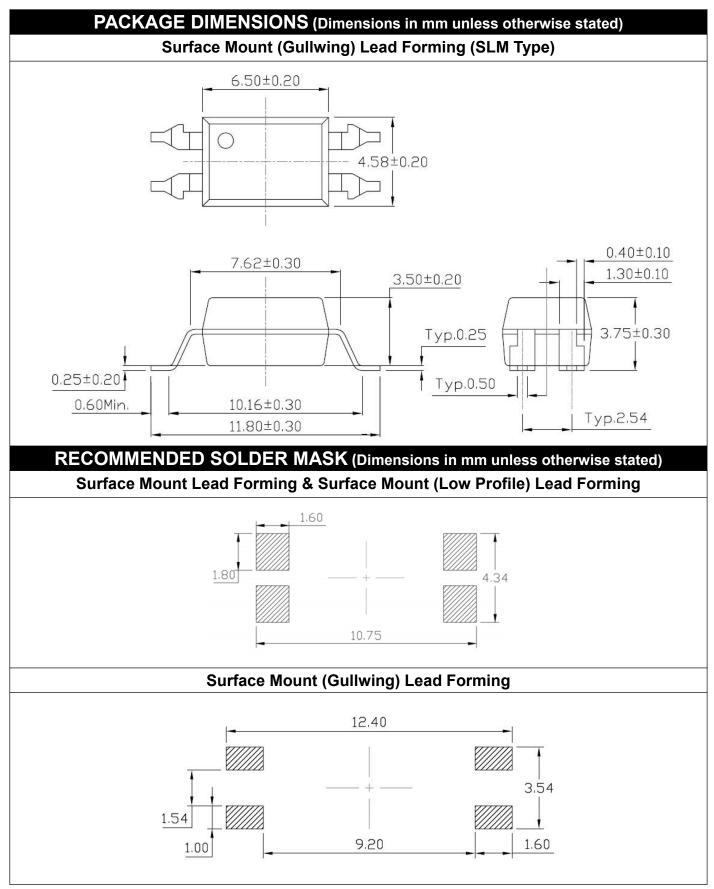
TD814 Series





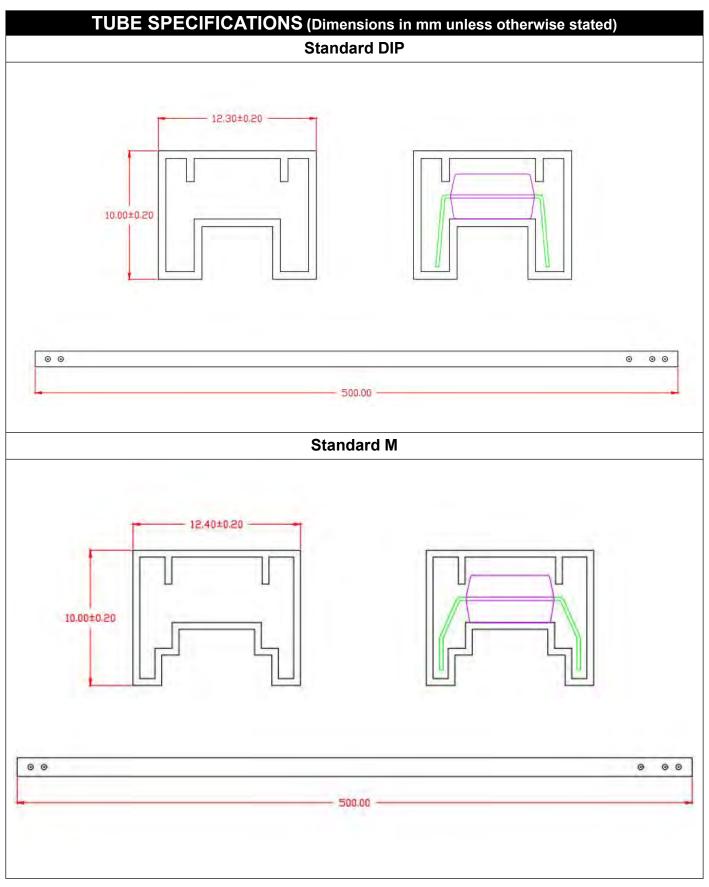
TD814 Series



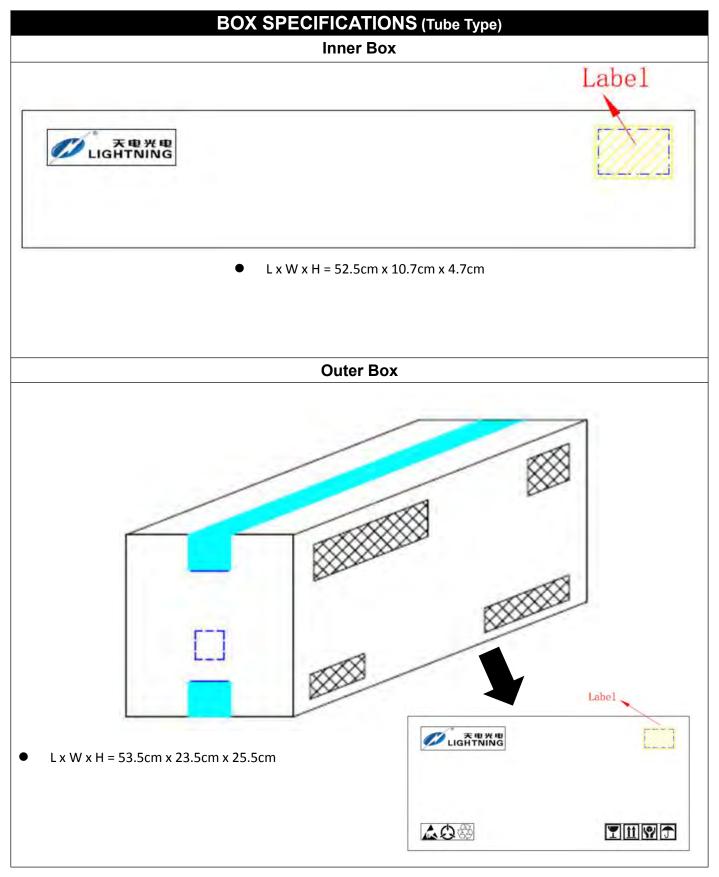


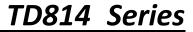


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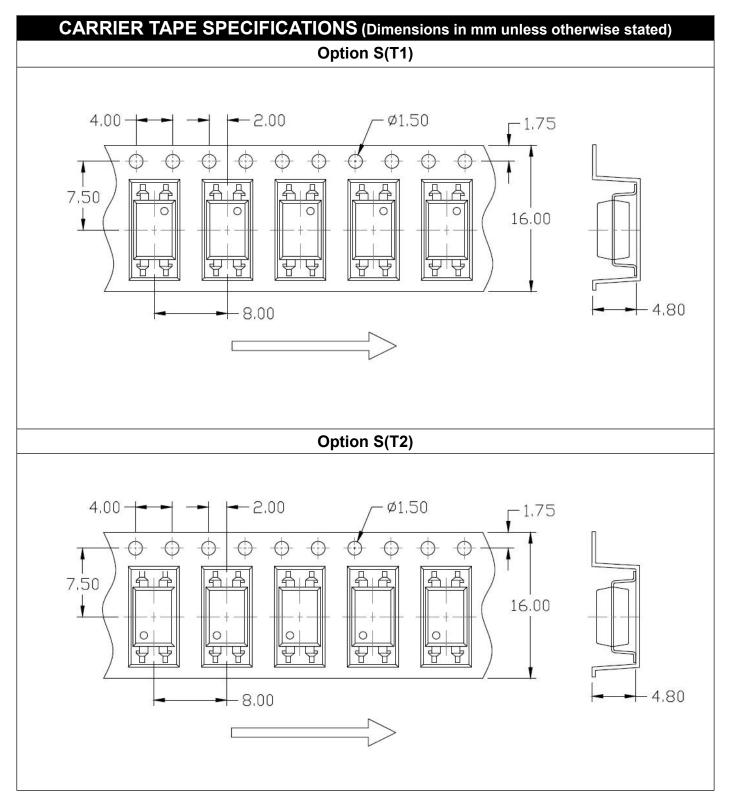






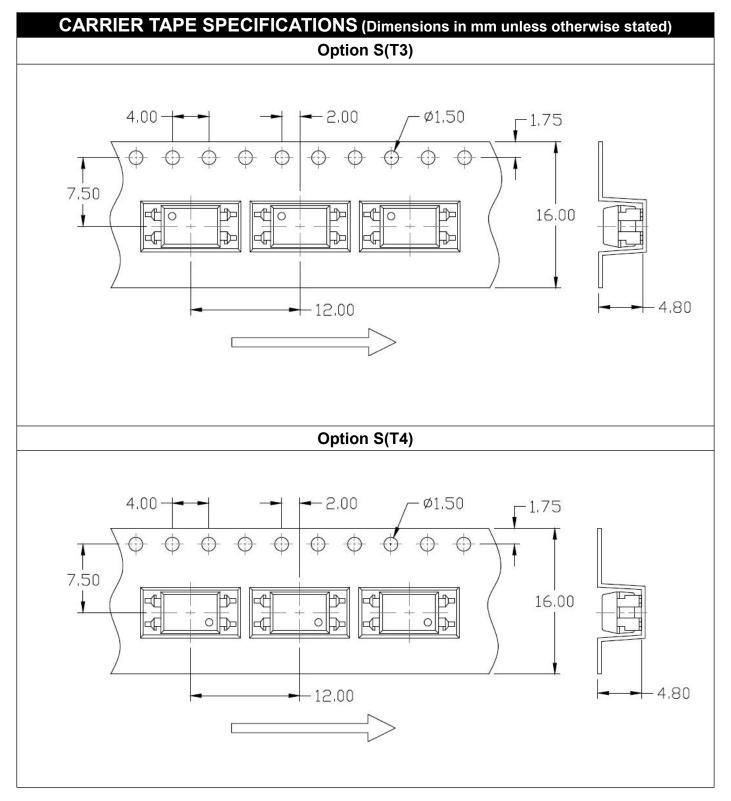


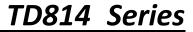




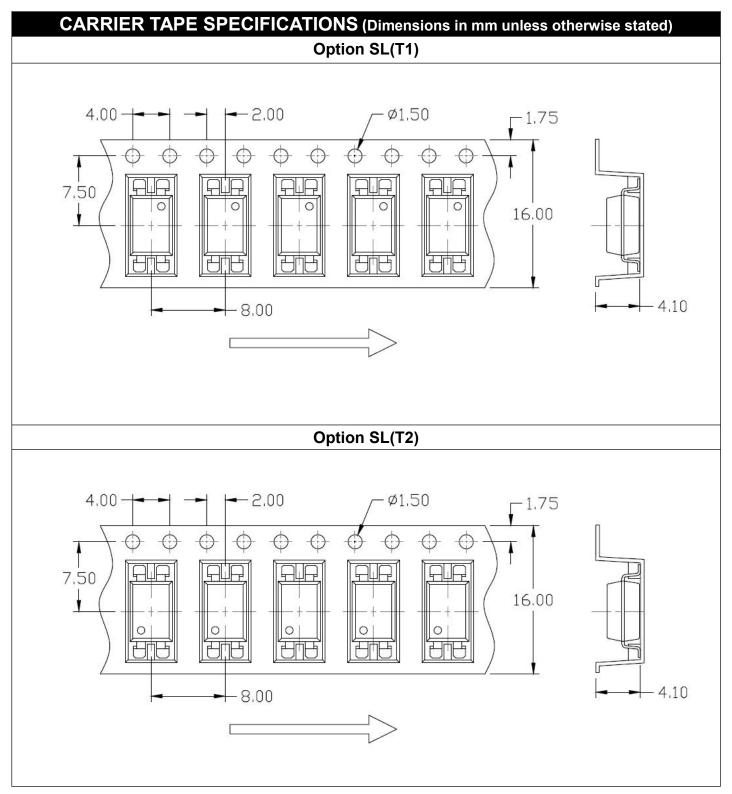


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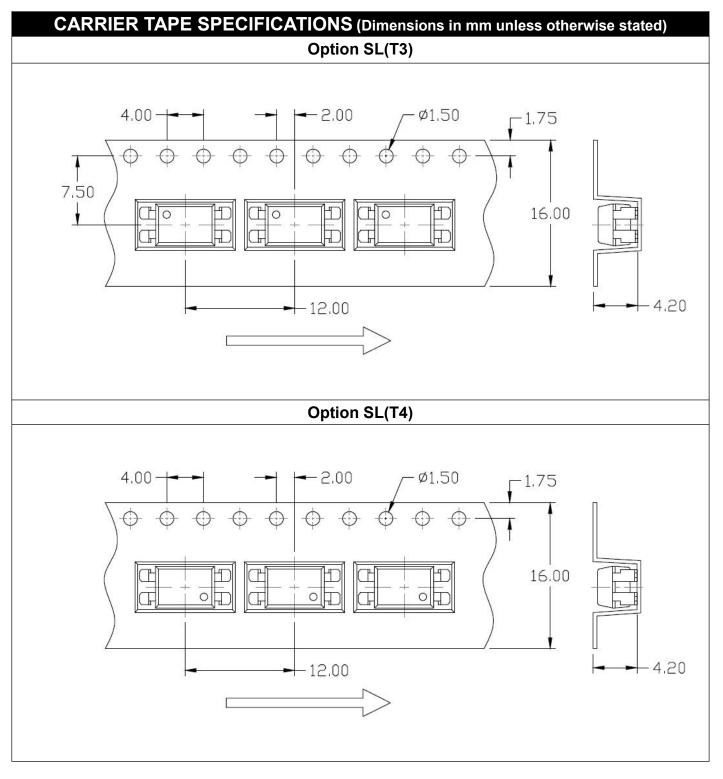






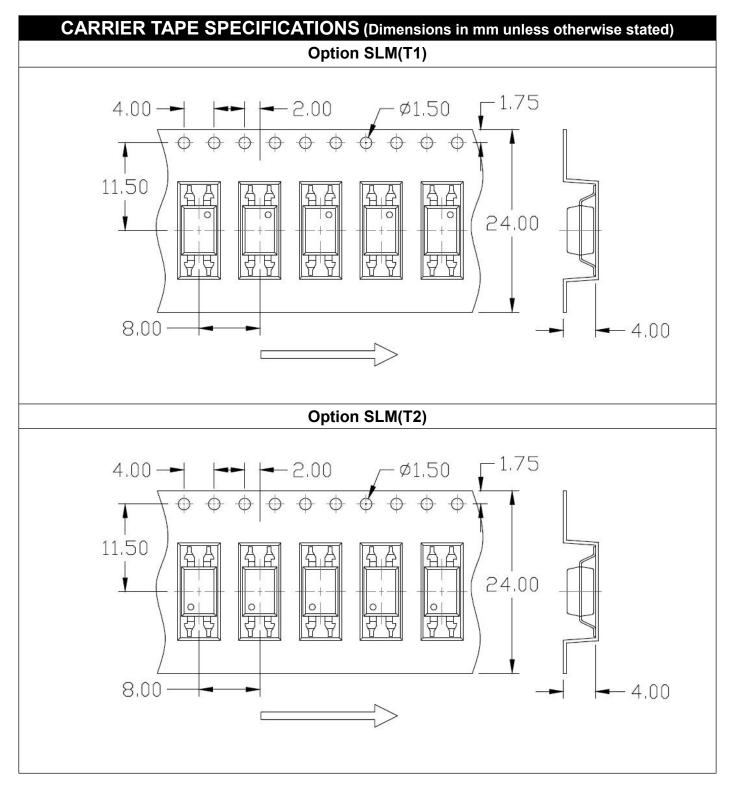


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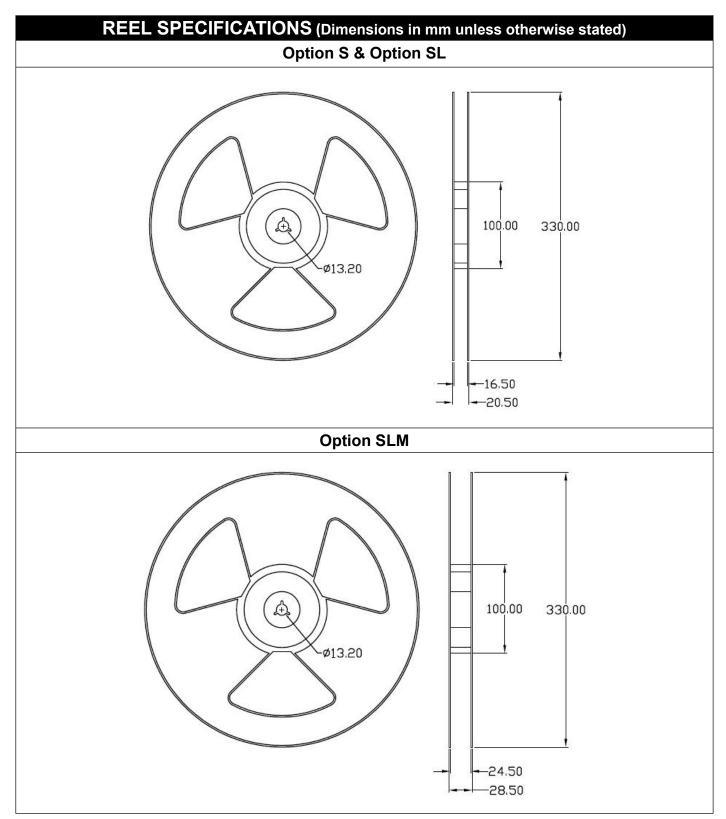






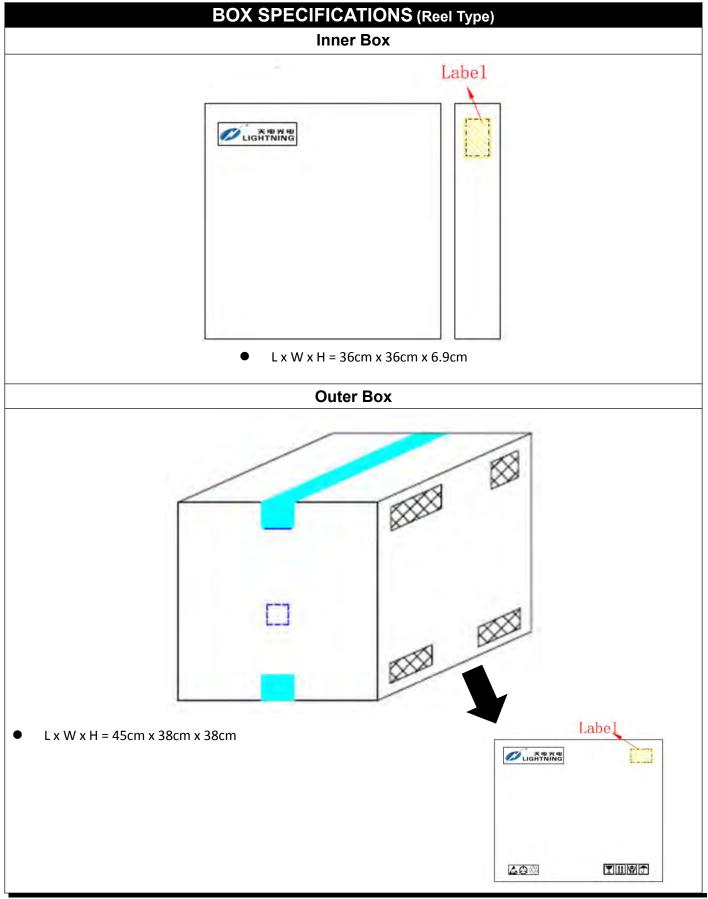
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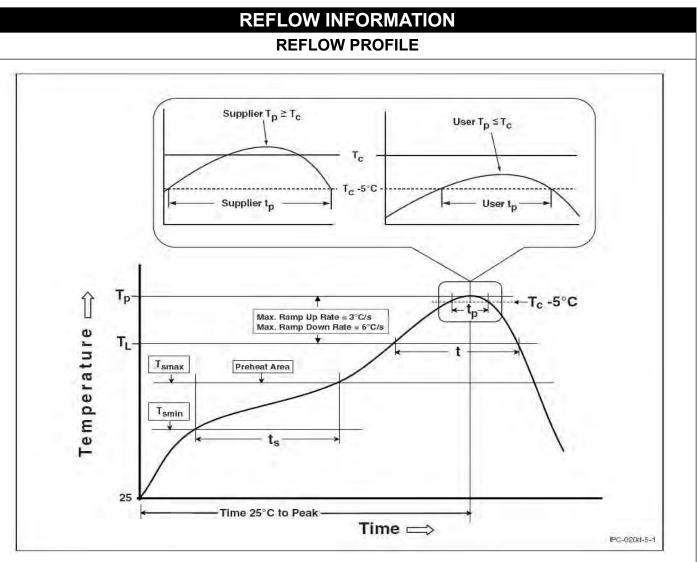


		AND MARI		FORMATION DN	
	T 814 VYAW		814 : X : V : Y : A :	Company Abbr. Part Number CTR Rank VDE Option Fiscal Year Manufacturing Code Work Week	
0	ORDERING INFORMATION		LABEL INFORMATION		
TD814X(Y)(Z)-GV		GV	福建天电光电有限公司		
TD – Company Abbr. 814 – Part Number X – Rank (A/B or None) Y – Lead Form Option (M/S/SL/SLM/None) Z – Tape and Reel Option (T1/T2/T3/T4) G – Green V – VDE Option (V or None)			Part No.:XXXXXXXXX Bin Code: X Lot No.: XXXXXXXXXX Date Code: XXXX QTY: XXX PCS MSL: 1 MSL: 1 Made in QuanZbou Fullan		
Packing Quantity					
Option	Quantity	Quantity – Inner box		Quantity – Outer box	

r doking Quantity				
Option	Quantity	Quantity – Inner box	Quantity – Outer box	
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T1)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T2)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	
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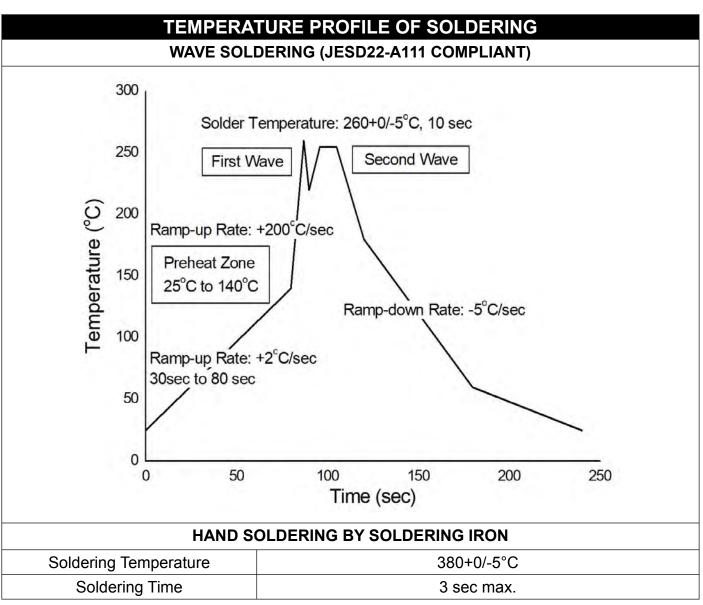


Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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DISCLAIMER

- LIGHTNING is continually improving the quality, reliability, function and design. LIGHTNING reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- LIGHTNING makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, LIGHTNING disclaims (a) any and all liability arising out of the application or use of any product, (b) any and all liability, including without limitation special, consequential or incidental damages, and (c) any and all implied warranties, including warranties of fitness for particular
- The products shown in this publication are designed for the general use in electronic applications such as office automation, equipment, communications devices, audio/visual equipment, electrical application and instrumentation purpose, non-infringement and merchantability.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.

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- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.